Flexible Printed Circuit Board Market Research Report- Global Forecast to 2022

Description:

Flexible Printed Circuit Board Market: By Type (Multi-layer Flex, Rigid Flex, Double-Sided Flex and Single-Sided Flex), By Application Area (Consumer Electronics, Manufacturing, Aerospace & Defense, Medical Devices, Automotive, Wearables and Others), and Region - Global Forecast Till 2023

Market Snapshot

It is projected that the global flexible printed circuit board market will exhibit a strong CAGR of 12.6% from 2018 to 2023. Factors such as increasing demand for consumer electronics, and the fast-growing popularity of flexible display technology are providing an impetus to the global flexible printed circuit board market. As traditional wire harnesses fail to cater to the application requirements of modern electronic components, they are being replaced by advanced flexible printed circuits. Over the years, flexible circuit technology has continued to evolve, enabling undertaking of complex component design. In addition, it is play an important role in miniaturization of electronic components.

Synopsis

This report offers a detailed analysis of the global flexible printed circuit board market along with a five-year (2018-2023) revenue analysis. The report covers some of the most important elements of the market. Market dynamics such as growth opportunities, trends and challenges are thoroughly discussed in the report. The scope of the discussion also covers different types of flexible printed circuit boards such as rigid flex, single-sided flex, multilayer flex and double-sided flex. The application areas for flexible printed circuit board considered in the report include consumer electronics, manufacturing, medical devices, automotive, aerospace & defense, wearables and others.

Companies Covered


The report provides insights on the leading market players and evaluates their current market share. Company information with regards to revenue, segmental share, geographical income, SWOT, growth strategies, new product launch, M&A activities, and the latest R&D initiatives is also available in the report.

Research Methodology

Market Research Future employs innovative statistical algorithms for conducting market study. Primary and secondary research methods are used to gain first-hand information about market trends. The statistical observations are then validated and supported by testimonies from stakeholders and industry insiders. Extensive analysis of the market allows to cover every parameter and provide extensive coverage of the competitive landscape and new revenue pockets. A multi-layered verification process reaffirms the research findings and revenue estimation in a broader way. MRFR strives to provide reliable and updated information about markets to help clients in decision-making and develop growth strategies.

Other Description

- Market Denomination- USD Mn
- Base Year- 2017
- Forecast Period- from 2018 to 2023

For the scope of the research, MRFR's report offers a comprehensive segmental analysis of the
global market for flexible printed circuit board

By Type
- Multilayer Flex
- Rigid Flex
- Double-Sided Flex
- Single-Sided Flex

By Application Area
- Consumer Electronics
- Manufacturing
- Aerospace & Defense
- Medical Devices
- Automotive
- Wearables
- Others

By Region
- North America
- Europe
- Asia Pacific
- Rest of the World (RoW)

Intended Audience
- Manufacturers and distributors of silicon-based materials.
- Suppliers and traders of wafers
- OEMs, device manufacturers, and semiconductors companies.
- Semiconductor foundries
- OEM and Semiconductor equipment providers
- Trade associations, research Institutions and universities, and small-scale devices manufacturers
Infographic Summary:

Global Flexible Printed Circuit Board Market

Globally the flexible printed circuit board market is expected to reach **USD 14,119.6 million** by 2023

**Global Flexible Printed Circuit Board Market, Market Share (%) 2017**

**Drivers**
- Increasing Demand for Consumer Electronics
- Increasing Adoption of Flexible Display Technology
- Rising Demand for Miniaturization of Electronic Components

**Restraint**
- High Manufacturing Costs

**Opportunity**
- Widening Application Scope of IoT

**Key Players**
- Sumitomo Electric Industries, Ltd
- NITTO DENTOKU CORPORATION
- Fujikura Ltd
- Zhen Ding Tech
- Career Technologies

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